

## N-Channel Enhancement Mode Power MOSFET

### Description

SMIRF7N65 is an N-channel enhancement mode power MOS field effect transistor. The improved planar stripe cell and the improved guard ring terminal have been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode.

These devices are widely used in AC-DC power suppliers, DCDC converters and H-bridge PWM motor drivers.

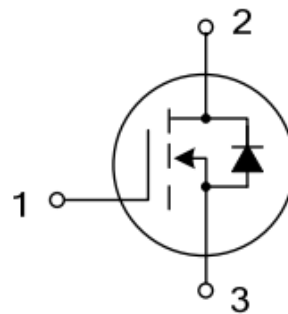
### General Features

- 7A, 650V,  $R_{DS(on)(typ.)} = 1.1\Omega @ V_{GS}=10V$
- Low Gate charge
- Low  $C_{rss}$
- Fast Switching
- Improved  $dv/dt$  Capability

### Application

- Power switching application
- Hard switched and high frequency circuits
- Uninterruptible power supply

$I_D$	7A
$V_{DSS}$	650V
$R_{dson (max)}$	$1.3\Omega (V_{GS}=10V, I_D=3.5A)$
$Q_g$	28nC



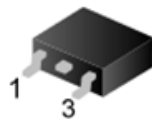
1.Gate 2.Drain 3.Source



TO-220



TO-220F



TO-252



## Order Information

Order Information	Marking ID	Package	Packing Type Supplied As
SMIRF7N65T9RL	IRF7N65	TO252-2L	3000 Units on Reel
SMIRF7N65T2TL	IRF7N65	TO220F-3L	1000 units on Box, 5000 units on Carton
SMIRF7N65T1TL	IRF7N65	TO220-3L	1000 units on Box, 5000 units on Carton

## Absolute Maximum Ratings Ta=25 °C unless otherwise noted

Parameter	Symbol	Value	Unit
Drain-source Voltage	V <sub>DS</sub>	650	V
Gate-source Voltage	V <sub>GS</sub>	±30	V
Continuous Drain Current(Ta=25°C)	I <sub>D</sub>	7	A
Drain Current-Pulsed	I <sub>DM</sub>	28	A
Total Dissipation (Ta=25°C)	TO252	145	W
	TO220	145	
	TO220F	45	
Junction Temperature	T <sub>J</sub>	150	°C
Storage Temperature	T <sub>STG</sub>	-65 to 150	°C
Single Pulse Avalanche Energy	E <sub>AS</sub>	230	mJ
ESD HBM(Human Body Mode)		≥2000	V
ESD MM(Machine Mode)		≥200	V

## Electrical Characteristics Ta = 25°C

PARAMETER	Symbol	Test Condition	MIN	Typ	MAX	UNIT
Drain-source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V, I <sub>D</sub> =250μA	650			V
Gate Threshold Voltage	V <sub>GS(TH)</sub>	V <sub>GS</sub> =V <sub>DS</sub> , I <sub>D</sub> =250μA	2.0	3.0	4.0	V
Drain-source Leakage Current	I <sub>DSS</sub>	V <sub>DS</sub> =650V, V <sub>GS</sub> =0V			1	uA
Drain-Source Diode Forward Voltage	V <sub>SD</sub>	V <sub>GS</sub> =0V, I <sub>S</sub> =7A			1.4	V
Gate-body Leakage Current (V <sub>DS</sub> = 0)	I <sub>GSS</sub>	V <sub>GS</sub> =±30V			±100	nA
Static Drain-source On Resistance	R <sub>DSON</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =3.5A		1.1	1.3	Ω

**Note:** Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant in temperature etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings

## Thermal Characteristics Ta=25°C

PARAMETER		Symbol	TYP	MAX	UNIT
Maximum Junction-to-case	TO252	R <sub>QJC</sub>		2.5	°C/W
	TO220F, TO220			3.1	°C/W
Maximum Junction-to-Ambient	TO252	R <sub>QJA</sub>		63	°C/W
	TO220F, TO220			80	°C/W

**Note1:** Ensure that the channel temperature does not exceed 150°C

**Note2:** V<sub>DD</sub>=50V, T<sub>ch</sub>=25 °C(initial), I<sub>AS</sub>=7A, R<sub>g</sub>=25Ω

**Note3:** This transistor is sensitive to electrostatic and should be handled with care

## Dynamic Characteristics Ta = 25 °C

PARAMETER	Symbol	Test Condition	MIN	TYP	MAX	UNIT
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> =25V, V <sub>GS</sub> =0V, f=1.0MHZ		955		pF
output Capacitance	C <sub>oss</sub>			135		pF
Reverse Transfer Capacitance	C <sub>rss</sub>			16		pF
Gate Resistance	R <sub>g</sub>	V <sub>DS</sub> =0V, V <sub>GS</sub> =0V, f=1.0MHZ		1.8		Ω

## Switching Characteristics Ta=25 °C

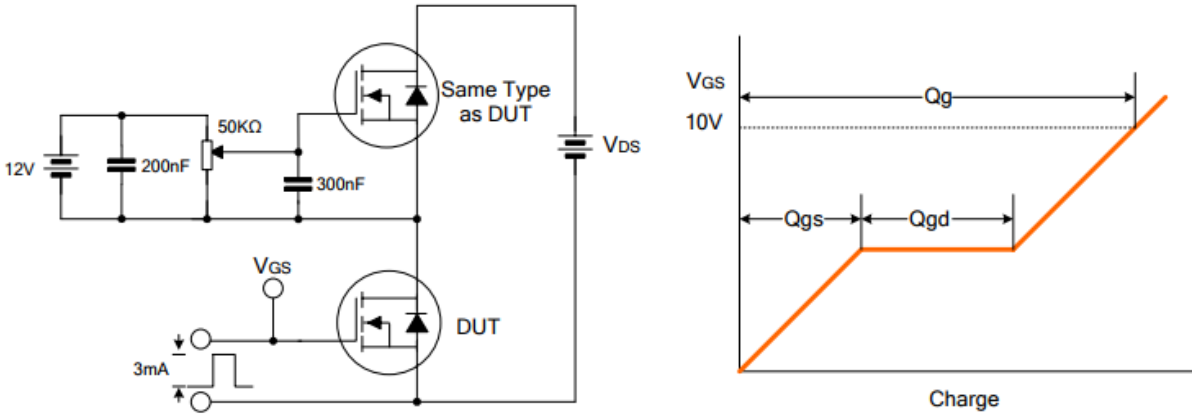
PARAMETER	Symbol	Test Condition	MIN	TYP	MAX	UNIT
Turn-On Delay Time	T <sub>d(on)</sub>	V <sub>DS</sub> =325V, I <sub>D</sub> =7A, V <sub>GS</sub> =10V, R <sub>G</sub> =25Ω		30		nS
Turn-On Rise Time	T <sub>r</sub>			80		nS
Turn-Off Delay Time	T <sub>d(off)</sub>			90		nS
Turn-Off Rise Time	T <sub>f</sub>			60		nS
Total Gate Charge	Q <sub>g</sub>	V <sub>DS</sub> =520V, I <sub>D</sub> =7A, V <sub>GS</sub> =10V		28		nC
Gate-Source Charge	Q <sub>gs</sub>			7		nC
Gate-Drain Charge	Q <sub>gd</sub>			12		nC

## Drain-Source Diode Maximum Ratings and Characteristics Ta=25 °C

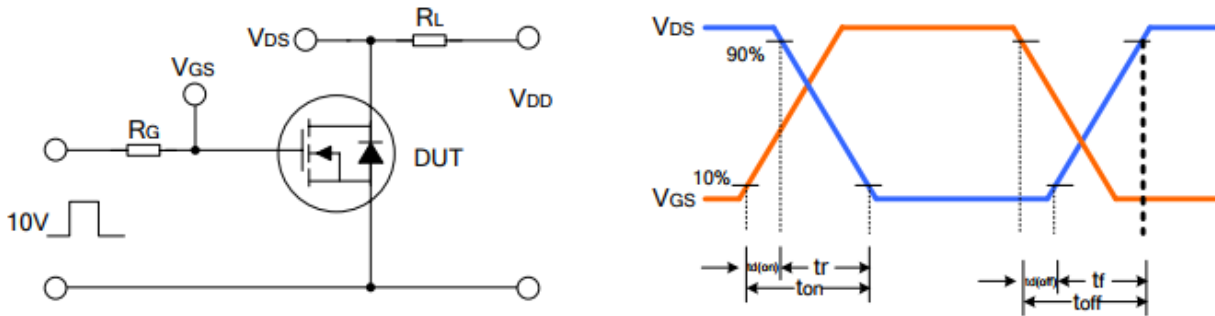
PARAMETER	Symbol	Test Condition	MIN	TYP	MAX	UNIT
Max. Diode Forward Current	I <sub>s</sub>	Integral Reverse P-N Junction Diode in the MOSFET			7	A
Pulsed Source Current	I <sub>sm</sub>				28	
Diode Forward Voltage	V <sub>SD</sub>	V <sub>GS</sub> =0V, I <sub>s</sub> =7A		0.92	1.5	V
Reverse Recovery Time	T <sub>rr</sub>	V <sub>GS</sub> =0V, I <sub>s</sub> =7A, dI <sub>F</sub> /dt=100A/μs		400		nS
Reverse Recovery Charge	Q <sub>rr</sub>				3.3	

## Test Circuit

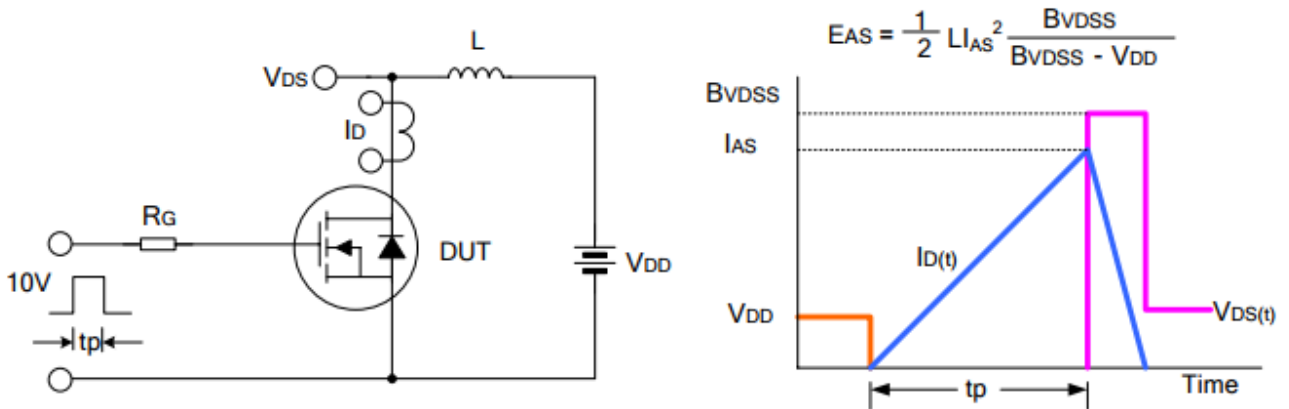
### Gate Charge Test Circuit & Waveform



### Resistive Switching Test Circuit & Waveform



### Unclamped Inductive Switching Test Circuit & Waveform



## Typical Characteristics Curve

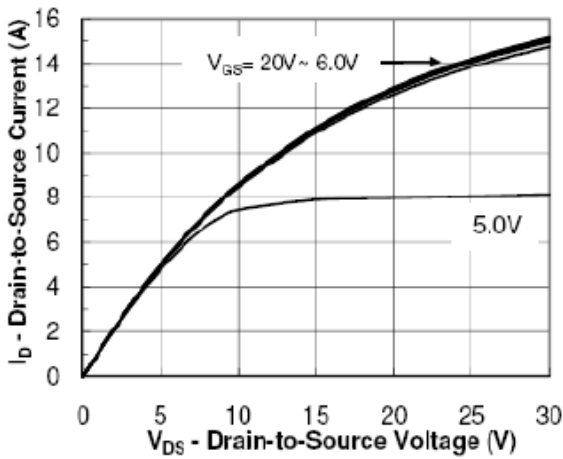


Figure 1: Output Characteristics

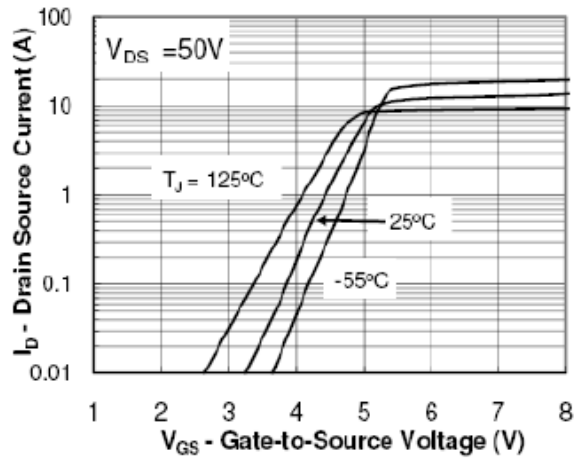


Figure 2: Transfer Characteristics

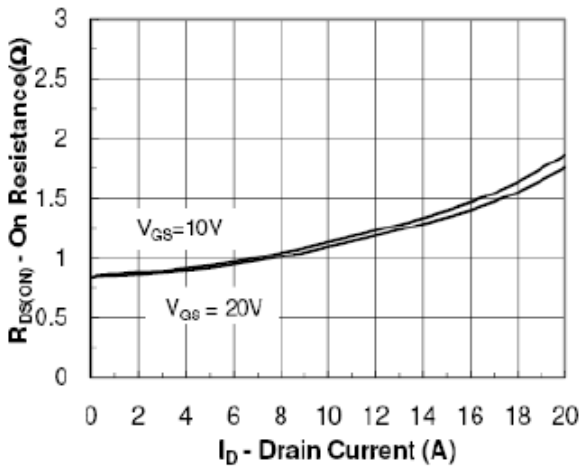


Figure 3: On Resistance Vs Drain Current

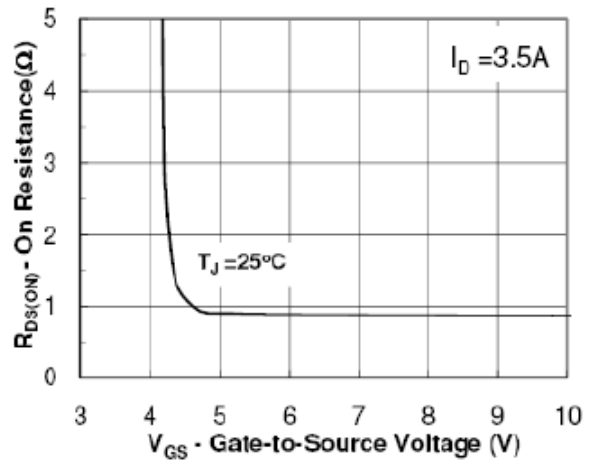


Figure 4: On Resistance Vs Gate Source

Voltage

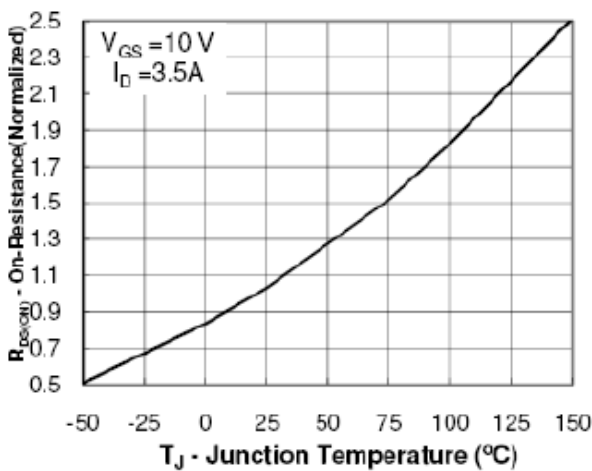


Figure 5: On Resistance Vs Junction Temperature Characteristics

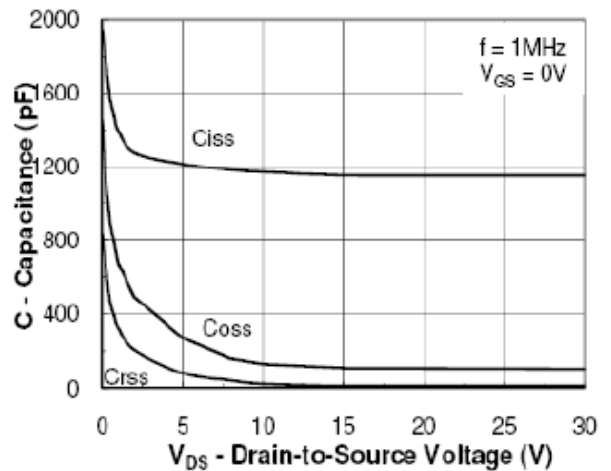


Figure 6: Capacitance

## Typical Characteristics Curve

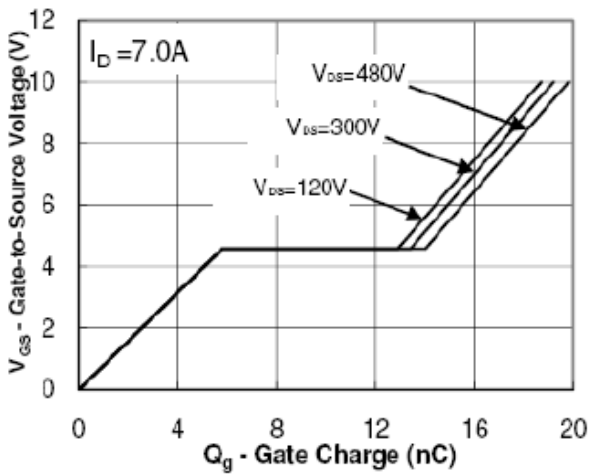


Figure7: Gate Charge Waveform

Forward Voltage

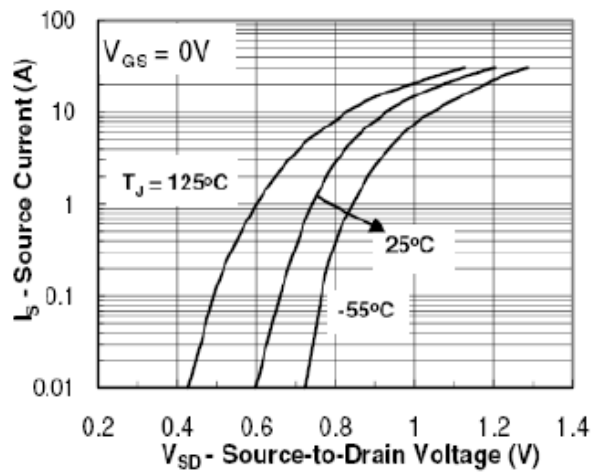


Figure8: Source-Drain Diode

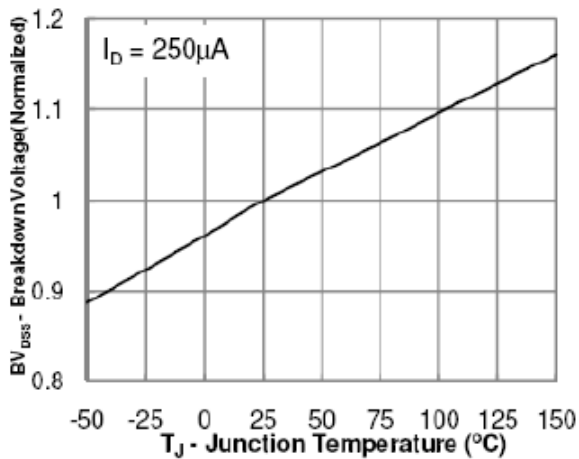
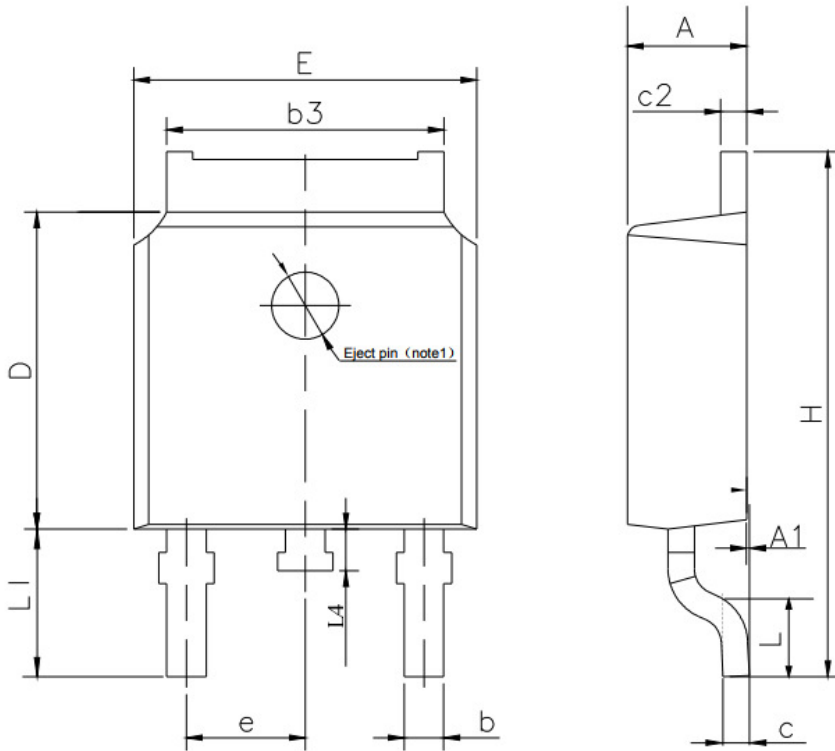


Figure9: Breakdown Voltage Vs Junction Temperature

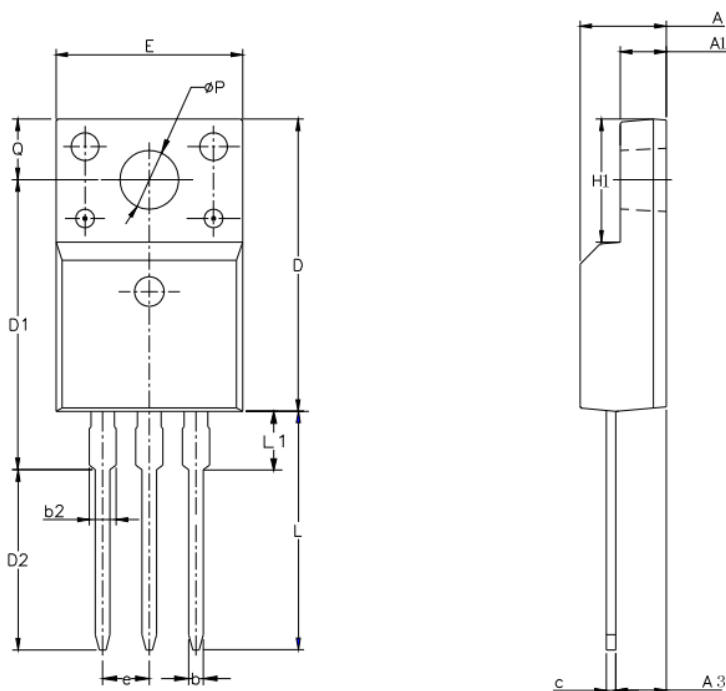
**Note:** The above characteristics curves are presented for reference only and not guaranteed by production test unless otherwise noted

## Outline Information (TO252-2L)



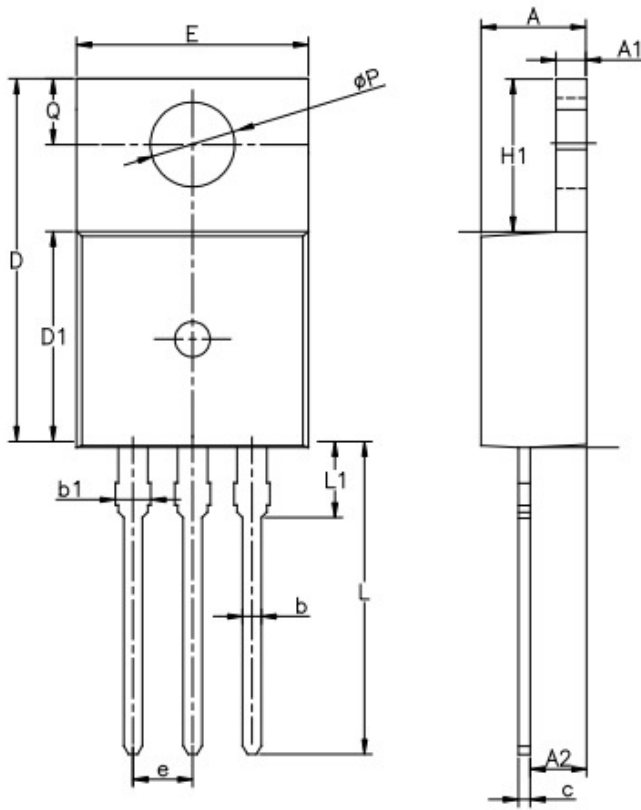
SYMBOL	MIN	NOM	MAX
A	2.10	2.30	2.50
A1	0	---	0.127
b	0.66	0.76	0.89
b3	5.10	5.33	5.46
c	0.45	---	0.65
c2	0.45	---	0.65
D	5.80	6.10	6.40
E	6.30	6.60	6.90
e	2.30TYP		
H	9.60	10.10	10.60
L	1.40	1.50	1.70
L1	2.90REF		
L4	0.60	0.80	1.00

## Outline Information (TO220F-3L)



SYMBOL	MIN	NOM	MAX
A	4.42	4.70	5.02
A1	2.30	2.54	2.80
A3	2.50	2.76	3.10
b	0.70	0.80	0.90
b2	—	—	1.47
c	0.35	0.50	0.65
D	15.25	15.87	16.25
D1	15.30	15.75	16.30
D2	9.30	9.80	10.30
E	9.73	10.16	10.36
e	2.54BCS		
H1	6.40	6.68	7.00
L	12.48	12.98	13.48
L1	/	/	3.50
$\phi P$	3.00	3.18	3.40
Q	3.05	3.30	3.55

## Outline Information (TO220-3L)



SYMBOL	MIN	NOM	MAX
A	4.30	4.50	4.70
A1	1.00	1.30	1.50
A2	1.80	2.40	2.80
b	0.60	0.80	1.00
b1	1.00	—	1.60
c	0.30	—	0.70
D	15.10	15.70	16.10
D1	8.10	9.20	10.00
E	9.60	9.90	10.40
e	2.54BSC		
H1	6.10	6.50	7.00
L	12.60	13.08	13.60
L1	—	—	3.95
$\phi P$	3.40	3.70	3.90
Q	2.60	—	3.20



## X-ON Electronics

Largest Supplier of Electrical and Electronic Components

*Click to view similar products for [MOSFET](#) category:*

*Click to view products by [SPS](#) manufacturer:*

Other Similar products are found below :

[614233C](#) [648584F](#) [MCH3443-TL-E](#) [MCH6422-TL-E](#) [FDPF9N50NZ](#) [FW216A-TL-2W](#) [FW231A-TL-E](#) [APT5010JVR](#) [NTNS3A92PZT5G](#)  
[IRF100S201](#) [JANTX2N5237](#) [2SK2464-TL-E](#) [2SK3818-DL-E](#) [FCA20N60\\_F109](#) [FDZ595PZ](#) [STD6600NT4G](#) [FSS804-TL-E](#) [2SJ277-DL-E](#)  
[2SK1691-DL-E](#) [2SK2545\(Q,T\)](#) [D2294UK](#) [405094E](#) [423220D](#) [MCH6646-TL-E](#) [TPCC8103,L1Q\(CM](#) [367-8430-0972-503](#) [VN1206L](#)  
[424134F](#) [026935X](#) [051075F](#) [SBVS138LT1G](#) [614234A](#) [715780A](#) [NTNS3166NZT5G](#) [751625C](#) [873612G](#) [IRF7380TRHR](#)  
[IPS70R2K0CEAKMA1](#) [RJK60S3DPP-E0#T2](#) [RJK60S5DPK-M0#T0](#) [APT5010JVFR](#) [APT12031JFLL](#) [APT12040JVR](#) [DMN3404LQ-7](#)  
[NTE6400](#) [JANTX2N6796U](#) [JANTX2N6784U](#) [JANTXV2N5416U4](#) [SQM110N05-06L-GE3](#) [SIHF35N60E-GE3](#)